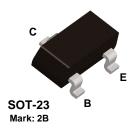


Discrete POWER & Signal **Technologies**

PN2907

MMBT2907





PNP General Purpose Amplifier

This device is designed for use as general purpose amplifiers and switches requiring collector currents to 500 mA. Sourced from Process 63. See PN2907A for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|-----------------------------------|---|-------|-------|
| V_{CEO} | Collector-Emitter Voltage | 40 | V |
| V _{CBO} | Collector-Base Voltage | 60 | V |
| V_{EBO} | Emitter-Base Voltage | 5.0 | V |
| I _C | Collector Current - Continuous | 800 | mA |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range -55 to +150 °C | | °C |

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol | Characteristic | Max Units | | Units |
|-----------------|--|------------|------------|-------------|
| | | PN2907 | *MMBT2907 | |
| P _D | Total Device Dissipation Derate above 25°C | 625 5.0 | 350 2.8 | mW mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | 357 | °C/W |

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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PNP General Purpose Amplifier (continued)

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|----------------------|--------------------------------------|---|-----------|----------|----------|
| | | | | | |
| OFF CHA | RACTERISTICS | | | | |
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage* | $I_C = 10 \text{ mA}, I_B = 0$ | 40 | | V |
| V _{(BR)CBO} | Collector-Base Breakdown Voltage | $I_C = 10 \mu A, I_E = 0$ | 60 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 10 \mu A, I_C = 0$ | 5.0 | | V |
| I _{CEX} | Collector Cutoff Current | V _{CE} = 30 V | | 50 | nA |
| I _B | Base Cutoff Current | V _{BE} = 0.5 V | | 50 | nA |
| Ісво | Collector Cutoff Current | V _{CB} = 50 V, I _E = 0 V _{CB} = 50 V, I _E = 0, T _A = 150 °C | | 20 20 | nA μA |
| | | | | | |
| ON CHAF | RACTERISTICS* | | | | |
| h_{FE} | DC Current Gain | $V_{CE} = 10 \text{ V}, I_{C} = 0.1 \text{ mA}$ | 35 | | |
| | | $V_{CE} = 10 \text{ V}, I_{C} = 1.0 \text{ mA}$ | 50 | | |
| | | $V_{CE} = 10 \text{ V}, I_{C} = 10 \text{ mA}$ | 75 | 200 | |
| | | $V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$ $V_{CE} = 10 \text{ V}, I_C = 500 \text{ mA}$ | 100 30 | 300 | |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | $I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ | 30 | 0.4 | V |
| - OL(Sat) | | $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ | | 1.6 | V |
| $V_{\text{BE(sat)}}$ | Base-Emitter Saturation Voltage | $I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ | | 1.3 | V |
| | | $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ | | 2.6 | V |
| | | | | | |
| SMALL S | IGNAL CHARACTERISTICS | | | | |
| C _{ob} | Output Capacitance | $V_{CB} = 10 \text{ V}, f = 1.0 \text{ MHz}$ | | 8.0 | pF |
| C_{ib} | Input Capacitance | $V_{EB} = 2.0 \text{ V, f} = 1.0 \text{ MHz}$ | | 30 | pF |
| h _{fe} | Small-Signal Current Gain | $I_C = 50 \text{ mA}, V_{CE} = 20 \text{ V},$ f = 100 MHz | 2.0 | | |
| | | | | | |
| SWITCHI | NG CHARACTERISTICS | | | | |
| t _{on} | Turn-on Time | $V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA},$ | | 45 | ns |
| t _d | Delay Time | I _{B1} = 15 mA , PW = 200 ns | | 10 | ns |
| t _r | Rise Time | 1 | | 40 | ns |
| t _{off} | Turn-off Time | $V_{CC} = 6.0 \text{ V}, I_{C} = 150 \text{ mA}$ | | 100 | ns |
| VOII | | 1 | | | <u> </u> |
| t _s | Storage Time | $I_{B1} = I_{B2} = 15 \text{ mA}$ | | 80 | ns |

^{*}Pulse Test: Pulse Width $\leq 300~\mu\text{s},~\text{Duty Cycle} \leq 2.0\%$

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|--------------------------|---------------------------|---|
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